



# Part No: PA.25A

#### **Description:**

Anam Hexa-Band Cellular SMT Antenna 800 MHz to 2200 MHz

#### **Features:**

Compact High Efficiency Antenna

Surface Mount Device

Dimensions: 35\*5\*6mm

Manufactured in an IATF16949 Approved Facility

RoHS & REACH Compliant



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# 1. Introduction PA-25

The PA.25A is ceramic cellular antenna designed for in-device mounting. The PA.25A is mounted through SMT process and can be used in varying applications based on it's small form factor of just 35\*6\*5mm.

Typical Applications Include:

- Body Worn Devices
- Hand-held IoT Devices
- Remote Monitoring

This ceramic multiband cellular antenna uses high grade ceramics which have been developed in Taoglas through years of expertise in delivering the right materials for high performance antennas. Taoglas, through constant research and development have designed a small form factor high efficiency antenna for use across cellular bands from 800MHz to 2170MHz.

The PA.25A is manufactured and tested in our IATF16949 approved facility.

The PA.25 is a unique SMT solution which is delivered on tape and reel. For very detailed integration information additional to this specification please download our comprehensive PA.25 integration application note from our website. For further information, please contact your regional Taoglas customer support team.



# 2. Specifications

	Electrical								
Band	Frequency (MHz)	Efficiency (%)	Average Gain (dB)	Peak Gain (dBi)	VSWR	Impedance	Polarization	Radiation Properties	Max Input Power
<b>4G/3G/NB-IoT/Cat M</b> Band 5,8,18,19,20,26,27	824~960	70	-1.55	2.00					
<b>4G/3G</b> Band 1,2,3,4,9,23,25,35,39,66	1710~2200	58	-2.39	3.51	<3:1	50Ω	Linear	Omnidirectional	5W
	Mechanical								
Dimensions	(mm)	35mm X 5mm X 6mm							
Materia	al	Ceramic							
Terminat	ion	Ag (environmental-friendly Pb free)							
Weigh	t	3g							
EVB Conne	ector	SMA-Female							
	Environmental								
Operation Temperature		-40°C to 85°C							
Storage Temp	Storage Temperature		-40°C to 105°C						
Moisture Sensitivity		Level 3							
RoHs Comp	RoHs Compliant		Yes						
REACH Compliant		Yes							

 $<sup>\</sup>ensuremath{^*}$  The antenna was tested on a 110  $\ensuremath{^*}$  40mm ground plane and covered by 2mm thick ABS plastic.

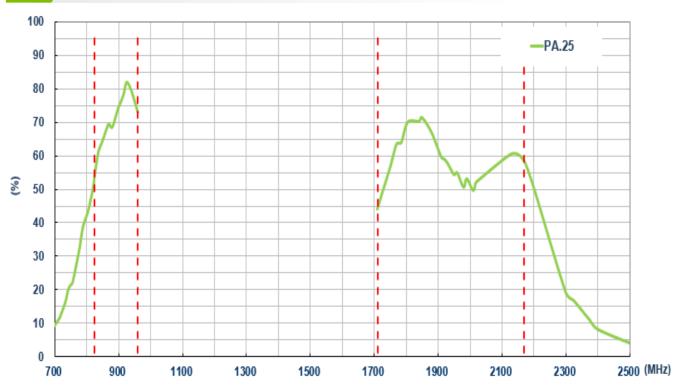
<sup>\*</sup> Actual Antenna Electrical performance will depend on customer ground plane size.



## 3. Antenna Characteristics



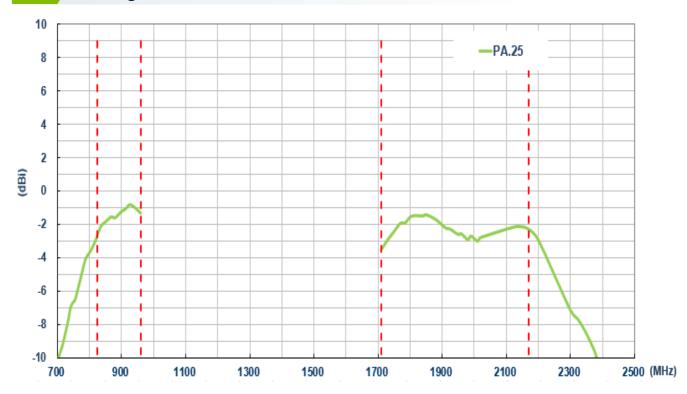












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## 4. Radiation Pattern

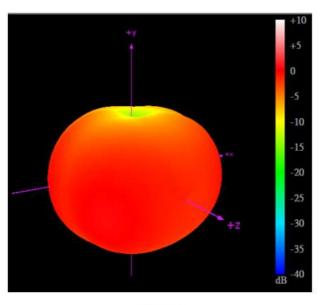
## 4.1 Test Setup on PAD.25 Evaluation Board

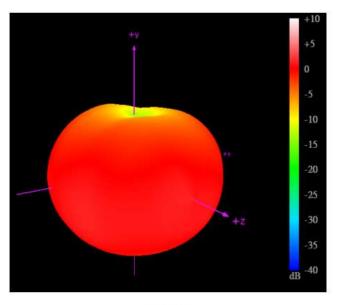


Chamber Test Set-up

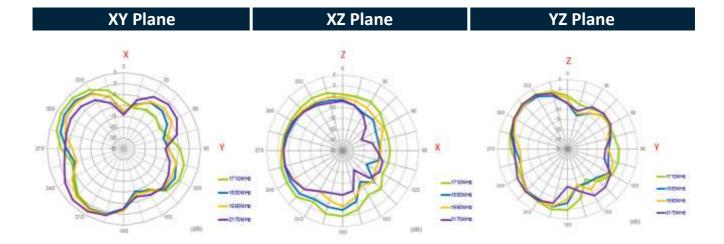


## 4.2 824/960MHz 3D and 2D Radiation Patterns



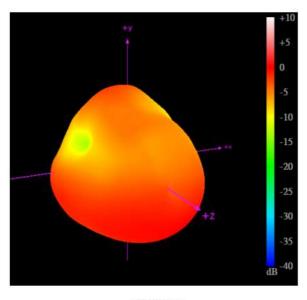


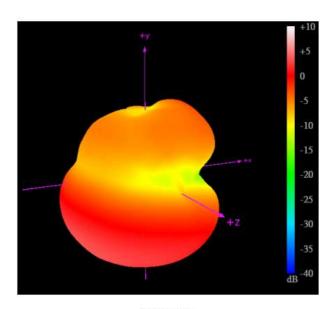
824MHz 960MHz



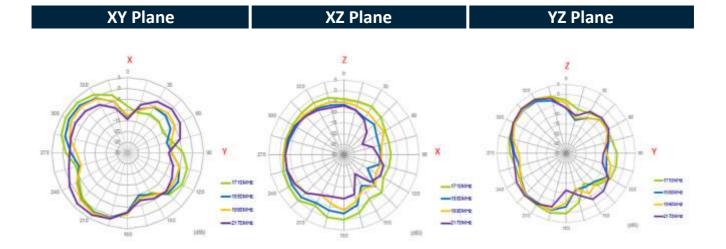


## 1710/1850MHz



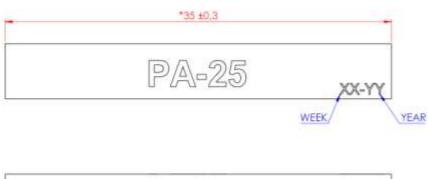


1710MHz 1850MHz





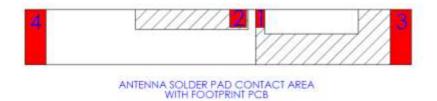
# 5. Mechanical Drawings (Unit:mm)

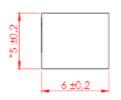


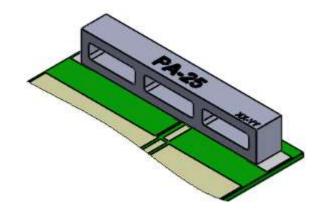


ANTENNA VIEW









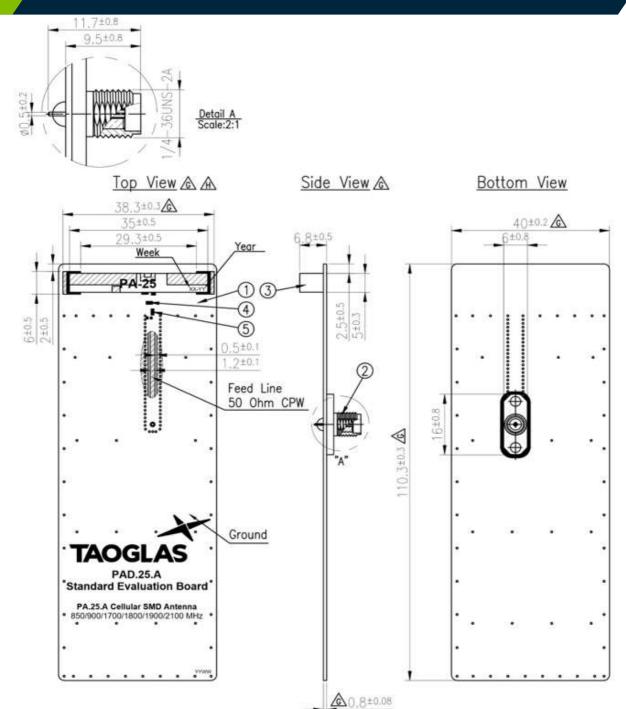
ANTENNA ON FOOTPRINT PCB VIEW SCALE 2:1

PIN:	DESCRIPTION:	
1	RF FEED (50 Ohm)	
2	GROUND	
3,4	NOT CONNECTED	

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## Eval Board Drawing (Unit: mm)



Note:

1.Week Batch Code

Example: 2010 Week 1=01.10

2.Silver

3.Soldered

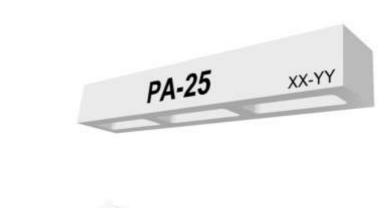
4.Logo & Text Ink Printing : White

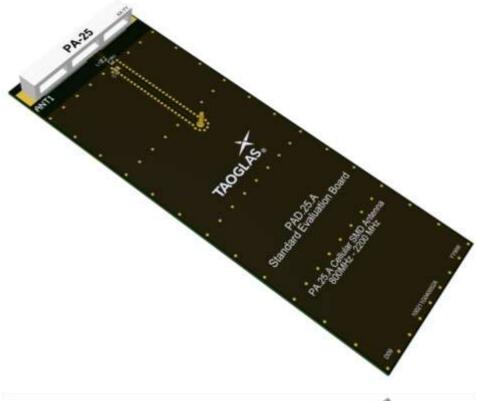
	Name	P/N	Material	Finish	QTY
1	PA.25.A EVB PCB	100211G040052A	Composite 0.8t	Black	1
2	SMA(F)ST PCB	200413B000002A	Brass	Au Plated	1
3	PA.25A Antenna	001513A020007A	Ceramics	White	1
4	6.8nH Inductor (0402)	001513A000055A	Ceramics	N/A	1
5	OΩ Resistor (0402)	001511J010012A	Ceramics	N/A	1

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# 7. Antenna Integration Guide





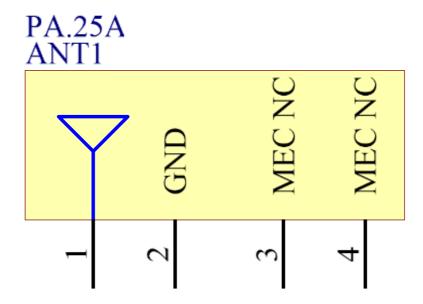




## 7.1 Schematic Symbol and Pin Definition

The circuit symbol for the antenna is shown below. The antenna has 4 pins with only two pins (Pin 1 and Pin 2) as functional. Pins 3 and 4 are for mechanical strength.

Pin	Description
1	RF Feed
2	Ground
3, 4	Mechanical, Not Connected



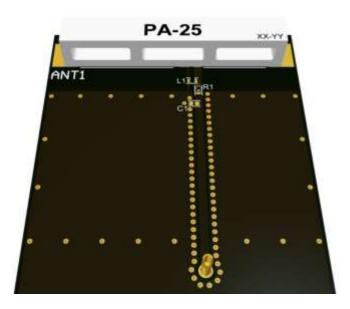
Please note you can download the design files, 3D model, 2D drawings and CST simulation files from the website here:

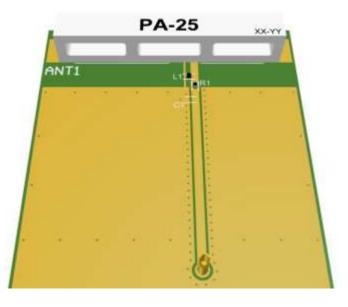
https://www.taoglas.com/product/anam-pa-25a-2g3g-smd-pifa-antenna-2/



#### 7.2 Antenna Integration

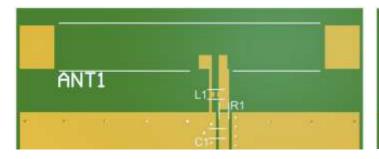
Whatever the size of the PCB, the antenna should ideally be placed on the PCB's shortest side, to take advantage of the ground plane. Optimized matching components can be placed as shown.





#### 7.3 PCB Layout

The footprint and clearance on the PCB must meet the antenna specification. An example of the PCB layout shows the antenna footprint with clearance. Note the placement of the optimized components. L1 is positioned outside the ground plane and R1 is sitting across the ground plane and the copper clearance area. C1 is optional as a component but it is recommended to include these pads in case they are needed.





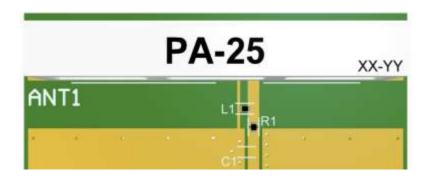
Topside Bottom Side



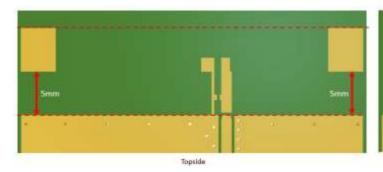
#### 7.4

#### **PCB Clearance**

The footprint and clearance on the PCB must meet the antenna specification. An example of the PCB layout shows the antenna footprint with clearance. Note the placement of the optimized components. L1 is positioned outside the ground plane and R1 is sitting across the ground plane and the copper clearance area. C1 is optional as a component but it is recommended to include these pads in case they are needed.

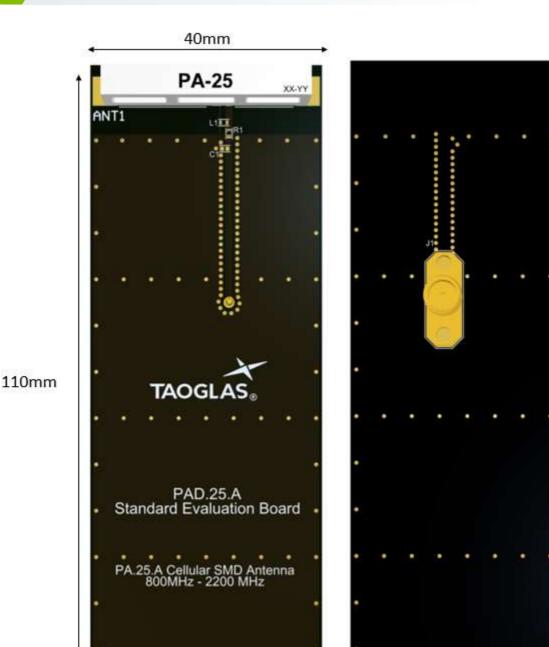


Below shows the antenna footprint and clearance through ALL layers on the PCB. Only the antenna pads and connections to feed and GND are present within this clearance area (marked RED). The clearance area extends to 5mm from the antenna mechanical pads to the ground area. This clearance area includes the bottom side and ALL internal layers on the PCB.





7.5 Evaluation Board



YYWW

**Bottom Side** 

100211G040052A

Topside



## 7.6 Evaluation Board Ground Plane Length

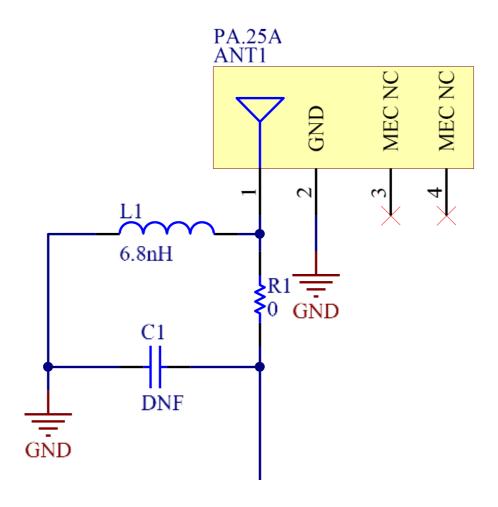


Ground Plane Length: 98mm



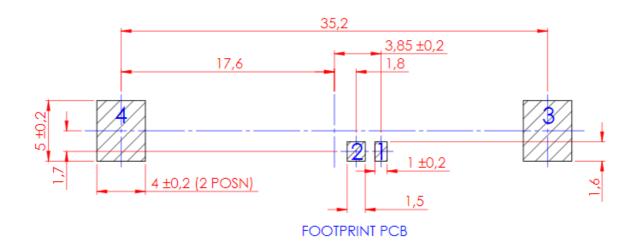
#### 7.7 Evaluation Board Matching Circuit

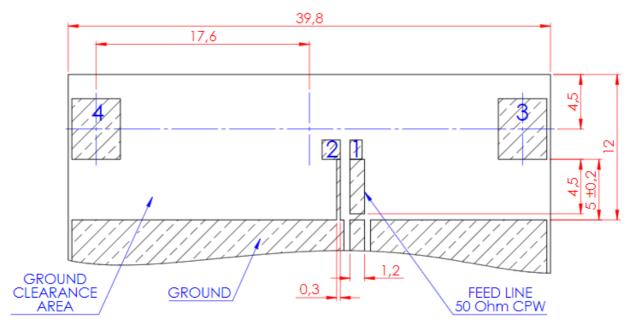
A matching component (L1) in parallel with the PA.25A is required for the antenna to have optimal performance on the evaluation board, located outside of the ground plane in the space specified in the above images. Additional matching components may be necessary for your device, so we recommend incorporating extra component footprints, forming a "pi" network, between the cellular module and the edge of the ground plane.



Designator	Туре	Value	Manufacturer	Manufacturer Part Number
L1	Inductor	6.8nH	TDK	MLK1005S6N8DT000
R1	Resistor	0Ω	Yageo	RC0402JR-070RL
C1	Capacitor	Not Fitted	-	-

## 7.8 Footprint





GROUND CLEARANCE <u>TOP</u> VIEW (SILKSCREEN NOT SHOWN)

PIN:	DESCRIPTION:
1	RF FEED (50 Ohm)
2	GROUND
3,4	NOT CONNECTED

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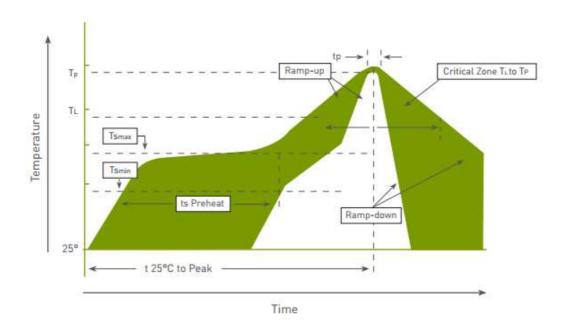


# 8. Recommended Reflow Temperature Profile

The PA.25 can be assembled following either Sn-Pb or Pb-Free assembly processes.

The recommended soldering temperatures are as follows:

Phase	Profile Features	Sn-Pb Assembly	(SnAgCu)  3°C/second (max)	
Ramp-Up	Avg Ramp-Up Rate [Tsmax to Tp]	3°C/second (max)		
1200 A 1200 Section 1	Temperature Min (Tsmin)	100°C	150°C	
Preheat	Temperature Max (Tsmax) Time (tsmin to tsmax)	150°C 60-120 seconds	200°C 60-120 seconds	
Reflow	Temperature $[T_L]$ Total Time Above $T_L$ b $[t_L]$	183°C 60-150 seconds	217°C 60-150 seconds	
Peak	Temperature (Tp) Time (tp)	235°C 10-30 seconds	260°C 20-40 seconds	
Ramp-Down	Rate	6°C/second (max)	6°C/second (max)	
Time from 25°	C to peak Temperature	6 minutes max	8 minutes max	

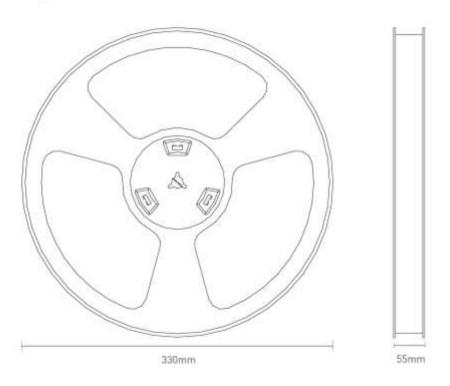


Temperature profile - [green area] for the assembly process in reflow ovens

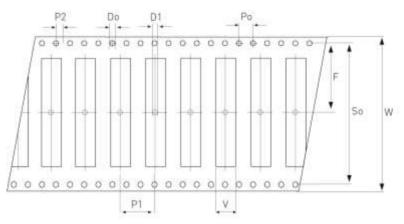


# 9. Packaging (Units; mm)

450 pc PA.25.A 1 reel per small inner box Dimensions - 330\*55mm Weight - 2000g



Symbol	Spec
Po	40±0.10
P1	12.0±0.10
P2	20±0.15
Do	1.5
D1	0.7
F	26.2±0.10
56	52.4±0.10
W	56.0 ± 0.30
.V.	55±0.10





#### Changelog for the datasheet

#### SPE-11-8-061 - PA.25A

Revision: L (Current Version)		
Date:	2022-02-23	
Changes:	Added integration guide	
Changes Made by:	Gary West	

#### **Previous Revisions**

Revision: K		
Date:	2020-11-10	
Changes:	Specifications table amended - Moisture Sensitivity Level 3	
Changes Made by:	Dan Cantwell	

Revision: F	
Date:	2013-03-21
Changes:	
Changes Made by:	Technical Writer

Revision: J	
Date:	2016-12-21
Changes:	
Changes Made by:	Technical Writer

Revision: E	
Date:	2012-12-06
Changes:	
Changes Made by:	Technical Writer

Revision: I	
Date:	2016-09-22
Changes:	Updated PAD, EBV drawing and image
Changes Made by:	Andy Mahoney

Revision: D	
Date:	2011-09-07
Changes:	
Changes Made by:	Technical Writer

Revision: H	
Date:	2016-01-18
Changes:	
Changes Made by:	Technical Writer

Revision: C	
Date:	
Changes:	
Changes Made by:	Technical Writer

Revision: G	
Date:	2013-09-03
Changes:	Amended Dimensions
Changes Made by:	Aine Doyle

Revision: B	
Date:	
Changes:	
Changes Made by:	Technical Writer

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Revision: A (Origina	l First Release)
Date:	2010-08-18
Notes:	
Author:	Technical Writer



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